

# FDP4N60NZ / FDPF4N60NZ **N-Channel MOSFET 600V**, **3.8A**, **2.5**Ω

# Features

- $R_{DS(on)} = 1.9\Omega$  (Typ.)@  $V_{GS} = 10V$ ,  $I_D = 1.9A$
- Low Gate Charge (Typ. 8.3nC)
- Low C<sub>rss</sub> (Typ. 3.7pF)
- · Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability
- ESD Improved Capability
- RoHS Compliant



# December 2011 UniFET-II<sup>™</sup>

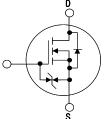
FDP4N60NZ / FDPF4N60NZ N-Channel MOSFET

# Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficient switching mode power supplies and active power factor correction.





# MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted\*

Symbol	Parameter			FDP4N60NZ	FDPF4N60NZ	Units
V <sub>DSS</sub>	Drain to Source Voltage		600		V	
V <sub>GSS</sub>	Gate to Source Voltage		±25		V	
I <sub>D</sub>	Drain Current	-Continuous ( $T_C = 25^{\circ}C$ )		3.8	3.8*	А
		-Continuous ( $T_c = 100^{\circ}C$ )		2.3	2.3*	
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	15	15*	А
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		223.8		mJ	
I <sub>AR</sub>	Avalanche Current		(Note 1)	3.8		А
E <sub>AR</sub>	Repetitive Avalanche Energy		(Note 1)	8.9		mJ
dv/dt	Peak Diode Recovery dv/dt	1	(Note 3)		10	V/ns
P <sub>D</sub>	Power Dissipation	$(T_{C} = 25^{\circ}C)$		89	28	W
		- Derate above 25°C		0.71	0.22	W/ºC
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150		°C	
Τ <sub>L</sub>	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds		300		°C	

\*Drain current limited by maximum junction temperature

# **Thermal Characteristics**

Symbol	Parameter	FDP4N60NZ	FDPF4N60NZ	Units
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.4	4.5	
$R_{\theta CS}$	Thermal Resistance, Case to Sink Typ	0.5		°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	62.5	62.5	

		Packag	ge Reel Size Tape		e Width		Quantit	у	
		TO-220	)				50		
FDPF4N60NZ FDPF4N60NZ TO-220		F			50				
Electrica	I Char	acteristics T <sub>c</sub> =	25°C unless	otherwise noted					
Symbol		Parameter		Test Condition	ons	Min.	Тур.	Max.	Units
Off Charac	teristic	S							
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage		$I_D = 250 \mu A, V_{GS} = 0V, T_C = 25^{\circ}C$		600	-	-	V	
ΔBV <sub>DSS</sub> ΔT <sub>J</sub>	Breakdown Voltage Temperature		$I_D = 250 \mu A$ , Referenced to $25^{\circ}C$		-	0.6	-	V/°C	
Zoro Coto Voltago Droip Curre		ant	$V_{DS} = 600V, V_{GS} = 0V$		-	-	1	μA	
DSS	Zero Gate Voltage Drain Current		$V_{DS} = 480V, V_{GS} = 0V, T_{C} = 125^{o}C$		-	-	10	μA	
I <sub>GSS</sub>	Gate to Body Leakage Current		$V_{GS} = \pm 25V, V_{DS} = 0V$		-	-	±10	μA	
On Charac	teristic	S							
V <sub>GS(th)</sub>	Gate Threshold Voltage		$V_{GS} = V_{DS}, I_{D} = 250 \mu A$		3.0	-	5.0	V	
R <sub>DS(on)</sub>	Static E	Drain to Source On Res	istance	$V_{GS} = 10V, I_D = 1.9A$		-	1.9	2.5	Ω
9 <sub>FS</sub>	Forward Transconductance		V <sub>DS</sub> = 20V, I <sub>D</sub> = 1.9A	(Note 4)	-	3.3	-	S	
Dynamic C	haract	eristics							
C <sub>iss</sub>		apacitance				-	385	510	pF
C <sub>oss</sub>	Output	put Capacitance		$V_{DS} = 25V, V_{GS} = 0V$	-	40	60	pF	
C <sub>rss</sub>	Revers	Reverse Transfer Capacitance		f = 1MHz	-	-	3.7	5	pF
Q <sub>g(tot)</sub>	Total G	Total Gate Charge at 10V Gate to Source Gate Charge Gate to Drain "Miller" Charge			ſ	-	8.3	10.8	nC
Q <sub>gs</sub>	Gate to			$V_{DS} = 480V I_{D} = 3.8A$		-	2.1	-	nC
Q <sub>gd</sub>	Gate to			V <sub>GS</sub> = 10V	(Note 4, 5)	-	3.3	-	nC
Switching	Charac	toristics							
t <sub>d(on)</sub>	Turn-On Delay Time					-	12.7	35.4	ns
t <sub>r</sub>		Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time		V <sub>DD</sub> = 300V, I <sub>D</sub> = 3.8A	-	-	15.1	40.2	ns
t <sub>d(off)</sub>	Turn-Of			$R_G = 25\Omega$	-	-	30.2	70.4	ns
t <sub>f</sub>	Turn-Of			-	(Note 4, 5)	-	12.8	35.6	ns
•	rce Dio	de Characteristic	s	1					
	urce Diode Characteristics			e Forward Current		-	-	3.8	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Fo			ward Current		-	-	15	Α
V <sub>SD</sub>	Drain to	Source Diode Forward	d Voltage	$V_{GS} = 0V, I_{SD} = 3.8A$		-	-	1.4	V
t <sub>rr</sub>	Reverse	e Recovery Time		$V_{GS} = 0V, I_{SD} = 3.8A$ $dI_F/dt = 100A/\mu s$ (Note 4)	-	168	-	ns	
Q <sub>rr</sub>	Povorce	e Recovery Charge			-	0.7	-	μC	

1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. L = 31mH, I\_{AS} = 3.8A, V\_DD = 50V, R\_G = 25 $\Omega$ , Starting T\_J = 25°C

3. I\_{SD}  $\leq$  3.8A, di/dt  $\leq$  200A/µs, V\_{DD}  $\leq$  BV\_{DSS}, Starting T\_J = 25°C

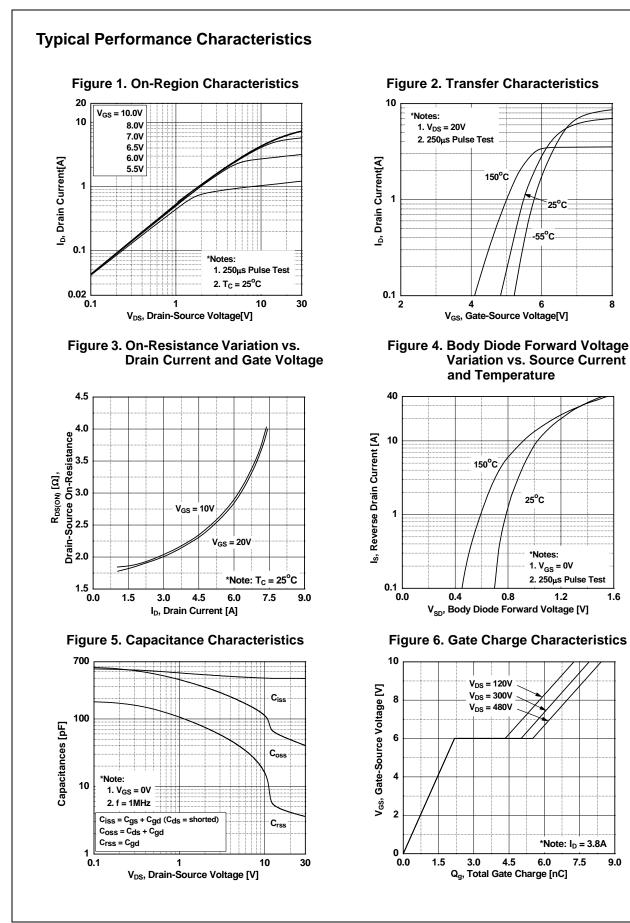
4. Pulse Test: Pulse width  $\leq 300 \mu \text{s}, \, \text{Dual Cycle} \leq 2\%$ 

5. Essentially Independent of Operating Temperature Typical Characteristics

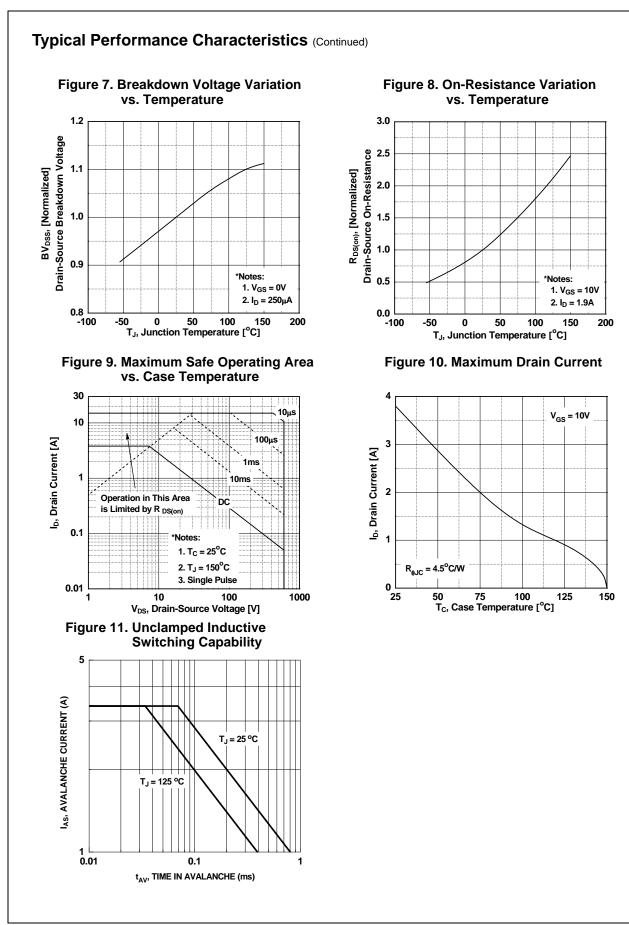


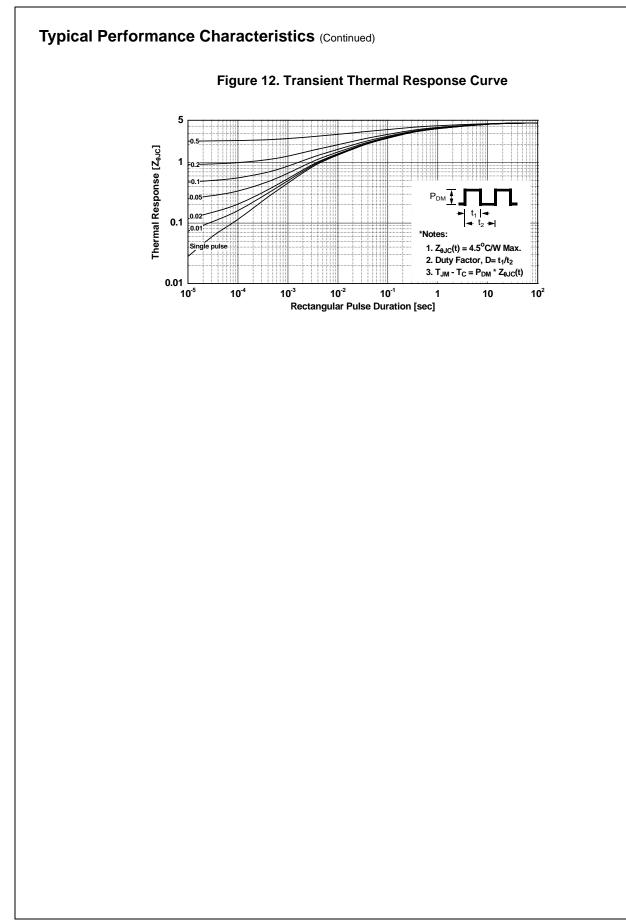
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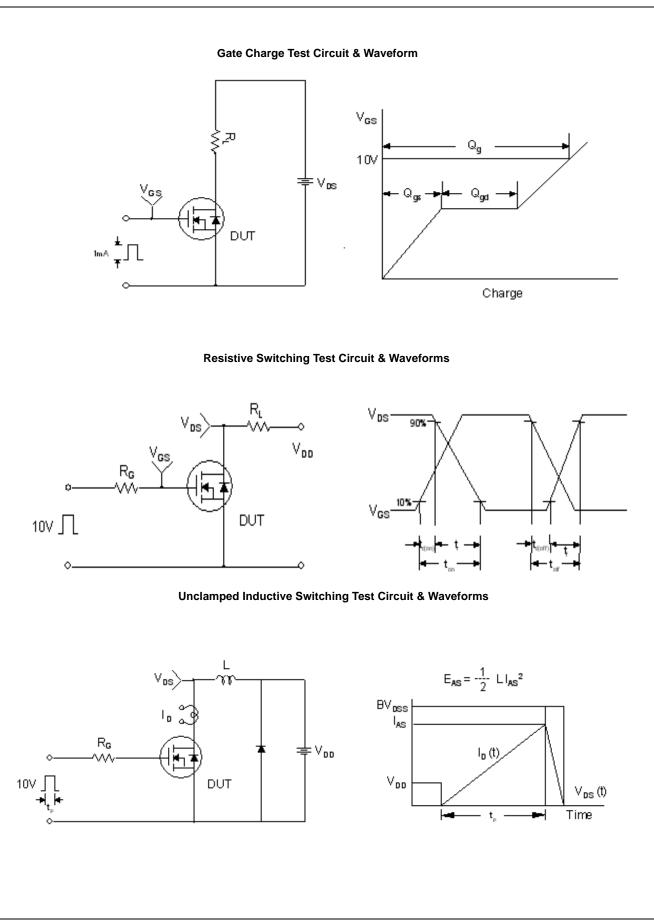
1.6



9.0

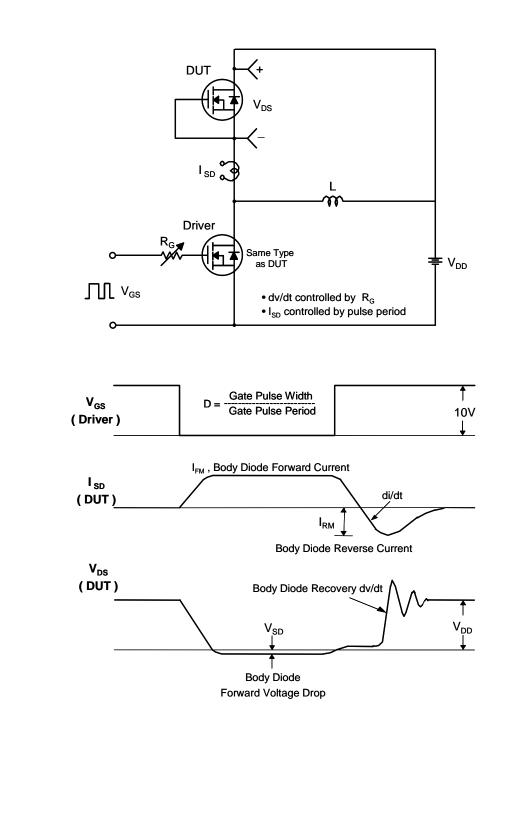


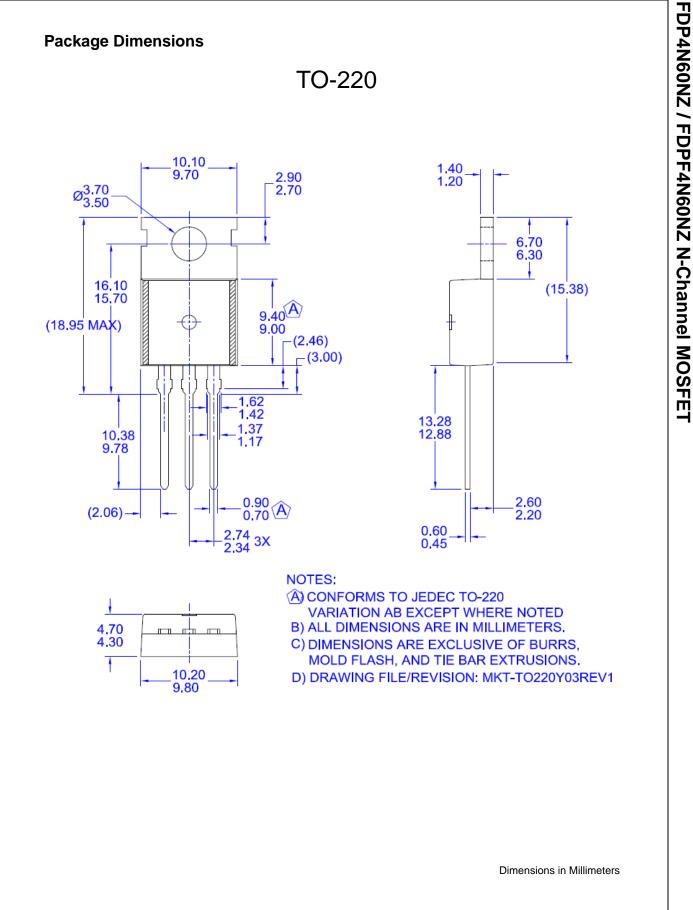


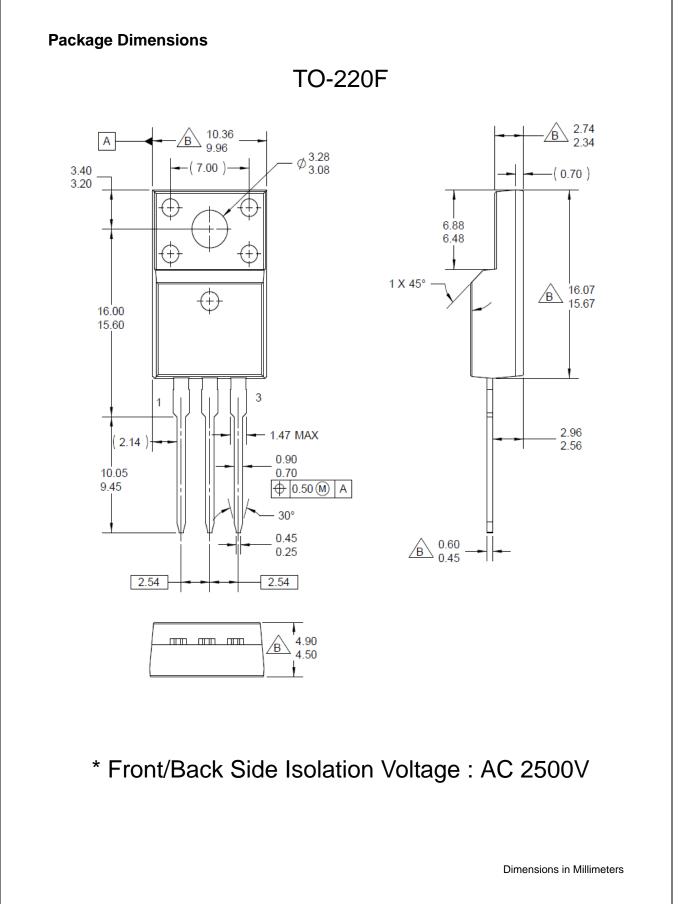


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